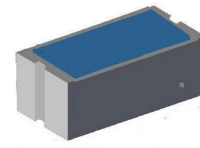


# 2.4GHz Chip Antenna: SURL502006T79

## Application:

WLAN, 802.11b/g, Bluetooth, etc...



## Features

SMD, high reliability, ultra Impact, Omni-directional...

## Part number

SURL 502006 T79 R 245  
 (1) (2) (3) (4) (5)

(1)Product Model	SURL
(2) Size Code	5.0x2.0x0.6mm
(3) Type Code	T79
(4) Packing	Tape and reel
(5) Frequency	2.45GHz

## Electrical Specification

Working Frequency Range	2400 ~2484 MHz
Peak Gain	3.5dBi (Typ.)
Impedance	50 Ohm
Return loss	10 dB ( Min)
Polarization	Linear
Azimuth Beamwidth	Omni-directional
Operation Temperature(°C)	-40 ~85°C

The specification is defined on EVB.

## Dimension and Terminal Configuration

**Top View**

**Side View**

**Bottom View**

Dimension (mm)	
L	5.0 +-0.20
W	2.0+- 0.20
T	0.60+-0.20
A	0.20+-0.20

No.	Terminal Name
1	Feeding
2	Soldering

FootPrint (Unit : mm)

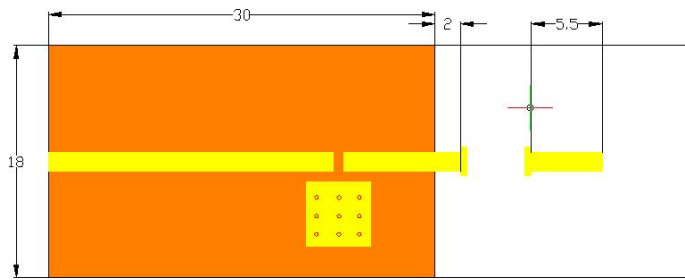
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# 2.4GHz 2.45GHz Chip Antenna: SURL502006T79

## Evaluation Board Reference

### PCB Dimension & Antenna Layout Reference

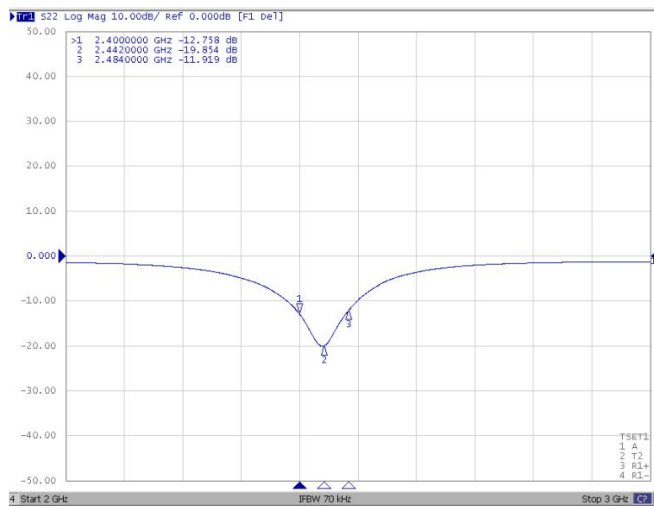


unit :mm

### Electrical Characteristics

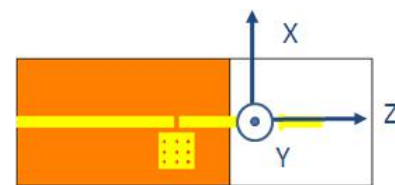
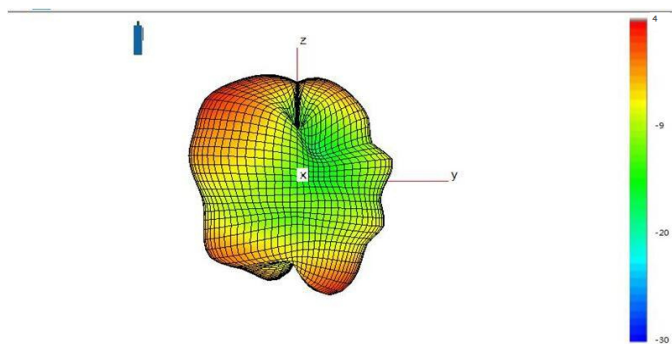
#### Return Loss & Radiation

##### Return Loss



Frequency (MHz)	S11 (dB)
2400	-12.8
2442	-19.8
2484	-11.9

##### Radiation



##### 2.45GHz

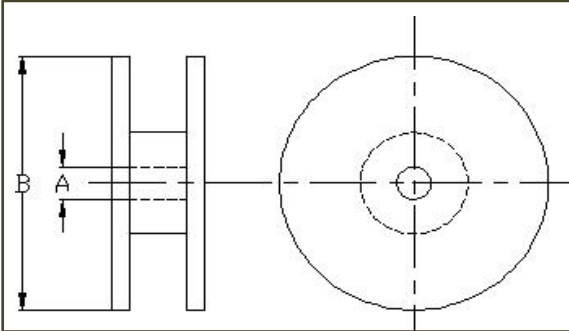
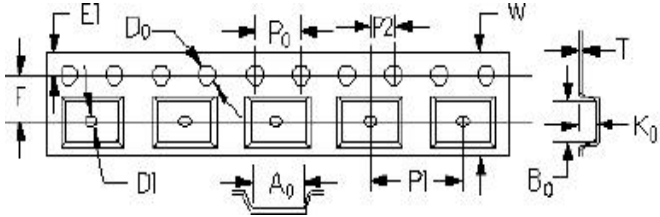
Frequency	2445MHz
Peak gain	3.5dBi
Efficiency	80.2%

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# 2.4GHz 2.45Hz Chip Antenna:SURL502006T79

## Taping Specifications

Reel			Taping Blister Tape		
					
Checking note	Index	Spec (mm)	Checking note	Index	Spec (mm)
Internal diameter of reel	A	60.20 ±0.50	Sprocket hole	D0	1.50 +0.10/-0.00
External diameter of reel	B	178 ±1.00	Distance sprocket hole to outside	E1	1.75 ± 0.10
			Distance sprocket hole to pocket	F	5.50 ± 0.05
			Distance sprocket hole to sprocket hole	P0	4.00 ± 0.10
			Distance pocket to pocket	P1	4.00 ± 0.10
			Distance sprocket hole to pocket	P2	2.00 ± 0.05
			Tape width	W	12.00 +0.30/-0.10
			Pocket width nominal clearance	A0	2.28 ±0.13
			Pocket length nominal clearance	B0	5.70 ±0.13
			Pocket depth minimum clearance	K0	1.58 ±0.10
			Thickness of tape	T	0.23 ±0.02
Quantity/per reel	3000 pcs				
Tape material	Plastic (embossed)				

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## 2.4GHz 2.45GHz Chip Antenna: SURL502006T79

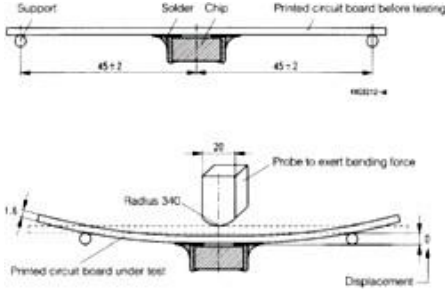
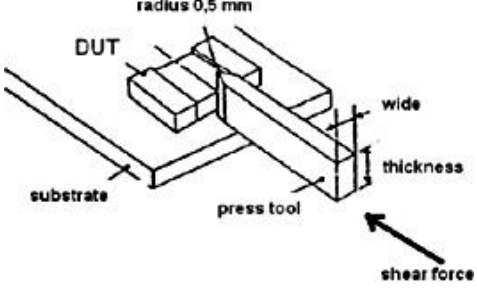
### Reliability Table

Test Item	Procedure	Requirements Ceramic Type	Remark (Reference)
<b>Electrical Characterization</b>		Fulfill the electrical specification	User Spec.
<b>Thermal Shock</b>	1. Preconditioning: $50 \pm 10^{\circ}\text{C}$ / 1 hr , then keep for $24 \pm 1$ hrs at room temp. 2. Initial measure: Spec: refer Initialspec. 3. Rapid change of temperature test: $-30^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ ; 100cycles; 15 minutes at Lower category temperature; 15 minutes at Upper category temperature.	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 107
<b>Temperature Cycling</b>	1. Initial measure: Spec: refer Initialspec. 2. 100 Cycles ( $-30^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ ), Soak Mode=1 (2 Cycle/hours). 3. Measurement at $24 \pm 2$ Hours after test condition.	No Visible Damage. Fulfill the electrical specification.	JESD22 JA104
<b>High Temperature Exposure</b>	1. Initial measure: Spec: refer Initialspec. 2. Unpowered; 500hours @ $T=+85^{\circ}\text{C}$ . 3. Measurement at $24 \pm 2$ hours after test.	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 108
<b>Low Temperature Storage</b>	1. Initial measure: Spec: refer Initialspec. 2. Unpowered: 500hours @ $T=-30^{\circ}\text{C}$ . 3. Measurement at $24 \pm 2$ hours after test.	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 108
<b>Solderability (SMD Bottom Side)</b>	Dipping method: a. Temperature: $235 \pm 5^{\circ}\text{C}$ b. Dipping time: $3 \pm 0.5\text{s}$	The solder should cover over 95% of the critical area of bottom side.	IEC 60384-21/22 4.10
<b>Soldering Heat Resistance (RSH)</b>	Preheating temperature: $150 \pm 10^{\circ}\text{C}$ . Preheating time: 1~2 min. Solder temperature: $260 \pm 5^{\circ}\text{C}$ . Dipping time: $5 \pm 0.5\text{s}$	No Visible Damage.	IEC 60384-21/22 4.10
<b>Vibration</b>	5g's for 20 min., 12 cycles each of 3 orientations Note: Use 8"X5" PCB .031" thick 7 secure points on, one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10-2000 Hz	No Visible Damage.	MIL-STD-202 Method 204
<b>Mechanical Shock</b>	Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen(18 shocks) Peak value: 1,500g's Duration: 0.5ms Velocity change: 15.4 ft/s Waveform: Half-sine	No Visible Damage.	MIL-STD-202 Method 213
<b>Humidity Bias</b>	1. Humidity: 85% R.H., Temperature: $85 \pm 2^{\circ}\text{C}$ . 2. Time: $500 \pm 24$ hours. 3. Measurement at $24 \pm 2$ hrs after test condition.	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 Method 106

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## 2.4GHz 2.45HHz Chip Antenna: SURL502006T79

<b>Board Flex (SMD)</b>	<p>1. Mounting method: IR-Reflow. PCB Size (L:100 × W:40 × T:1.6mm)</p> <p>2. Apply the load in direction of the arrow until bending reaches 2 mm.</p> 	No Visible Damage.	AEC-Q200 005
<b>Adhesion</b>	<p>Force of 1.8Kg for 60 seconds.</p> 	No Visible Damage Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body terminals and body/terminal junction.	AEC-Q200 006
<b>Physical Dimension</b>	<p>Any applicable method using x10 magnification, micrometers, calipers, gauges, contour projectors, or other measuring equipment, capable of determining the actual specimen dimensions.</p>	In accordance with specification.	JESD22 JB100

### Revision History

Revision	Date	Content
1	2019/7/20	New issue

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